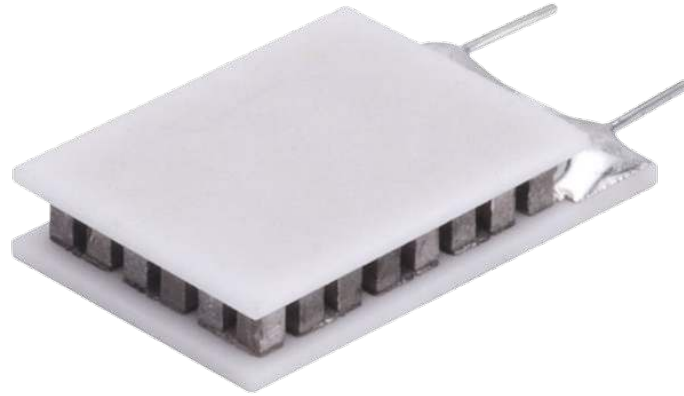


HiTemp ET Series Thermoelectric Cooler

Note: This product is not recommended for new designs.
 This product series has been replaced with the HiTemp ETX Series.
 The recommended replacement is:
 MFG Part Number: 387006906
 Description: OTX20-24-F2A-0709-11-W2.25

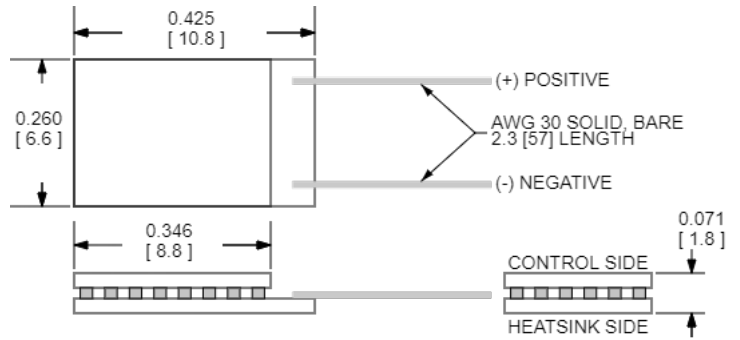


Features

- High-temperature operation
- Reliable solid-state
- No sound or vibration
- Environmentally-friendly
- RoHS-compliant

Applications

- Peltier Cooling for Refrigerated Centrifuges
- Peltier Cooling for Machine Vision
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Peltier Cooling for Digital
- Light Processors



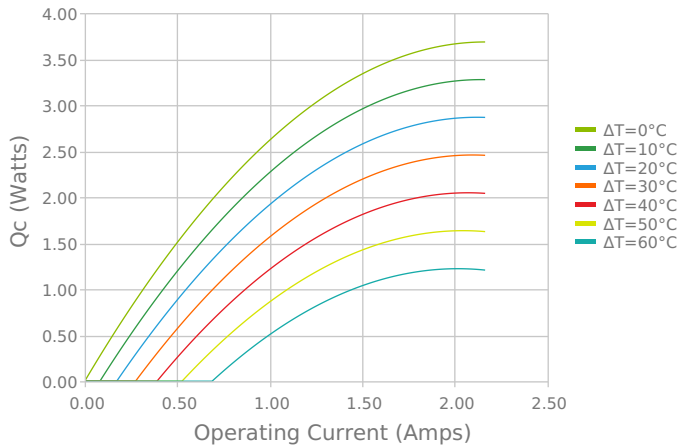
CERAMIC MATERIAL: Al₂O₃
 SOLDER CONSTRUCTION: 232°C, SbSn

INCHES [MM]

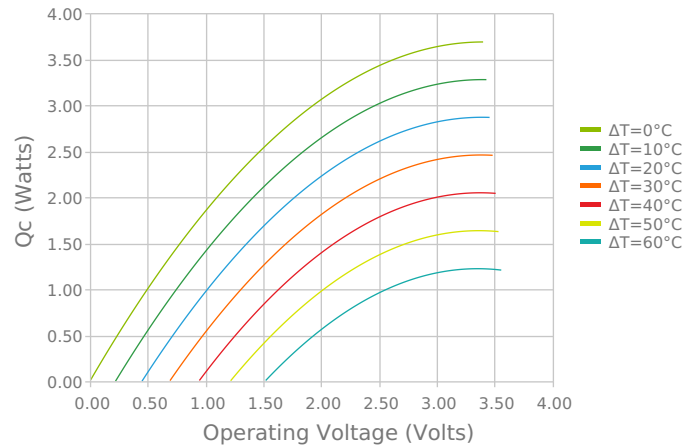
ELECTRICAL AND THERMAL PERFORMANCE

For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

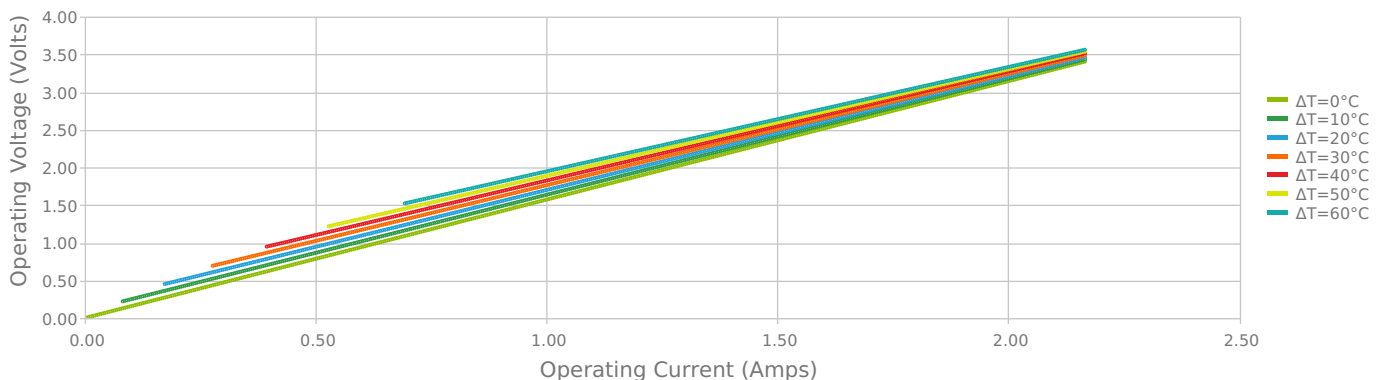
Heat Pumped at Cold Side
 Thot = 85 °C



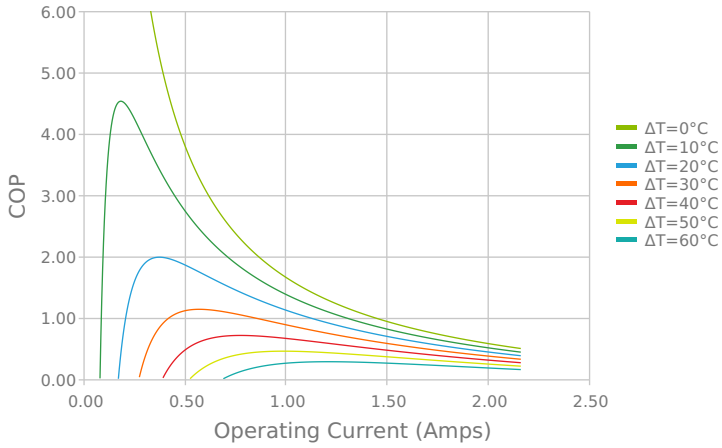
Heat Pumped at Cold Side
 Thot = 85 °C



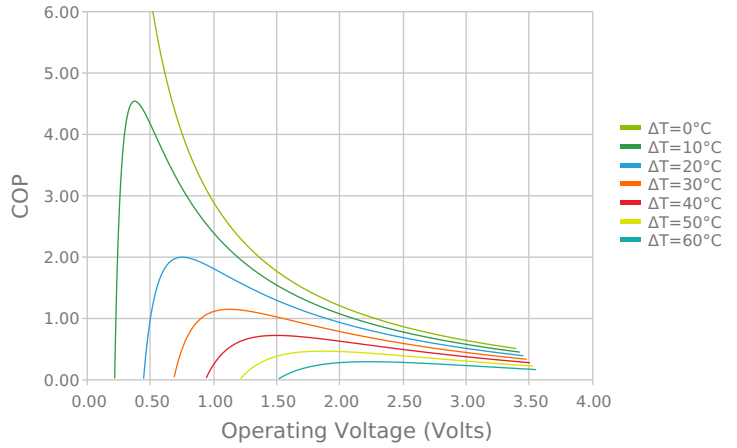
Current vs Voltage (I vs V)
 Thot = 85 °C



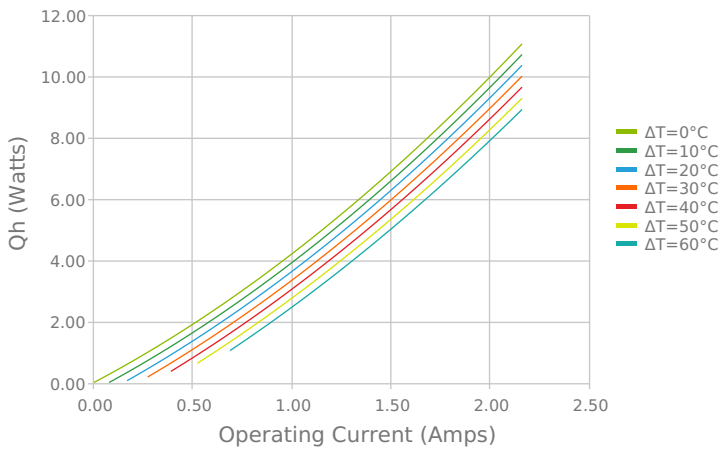
Coefficient of Performance (COP = Qc/Pin)
Thot = 85 °C



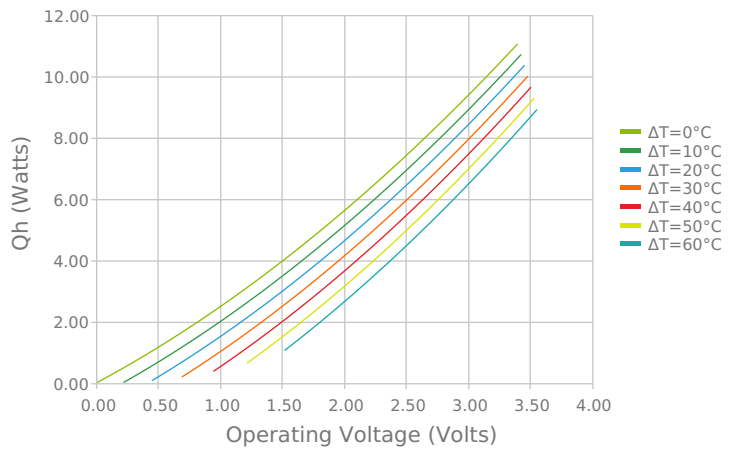
Coefficient of Performance (COP = Qc/Pin)
Thot = 85 °C



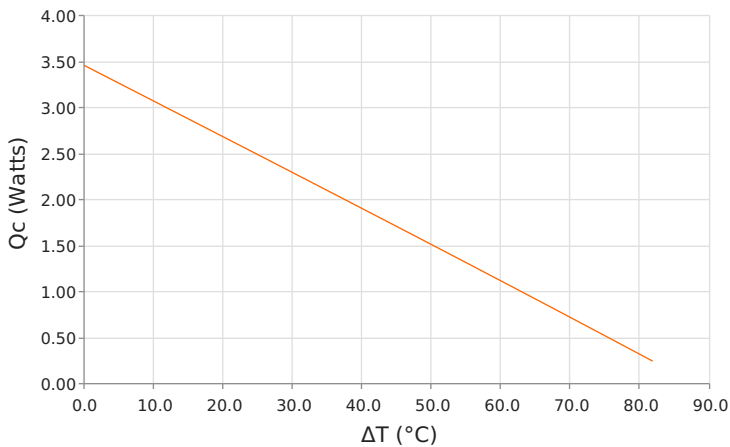
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
Thot = 85 °C



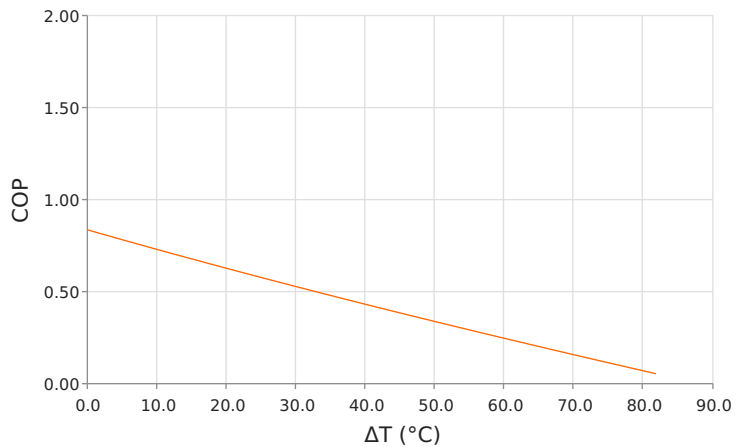
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
Thot = 85 °C



Heat Pumped at Cold Side (Qc)
Thot = 85 °C | Current = 1.6 Amps



Coefficient of Performance (COP = Qc/Pin)
Thot = 85 °C | Current = 1.6 Amps



SPECIFICATIONS*

| Hot Side Temperature | 50.0 °C | 85.0 °C | 110.0 °C |
|---|-------------|-----------|-----------|
| Qcmax ($\Delta T = 0$) | 3.4 Watts | 3.7 Watts | 3.8 Watts |
| ΔT_{max} ($Q_c = 0$) | 77.9°C | 89.3°C | 96.2°C |
| I_{max} (I @ ΔT_{max}) | 2.0 Amps | 1.9 Amps | 1.9 Amps |
| V_{max} (V @ ΔT_{max}) | 2.9 Volts | 3.3 Volts | 3.6 Volts |
| Module Resistance | 1.35 Ohms | 1.57 Ohms | 1.72 Ohms |
| Max Operating Temperature | 150 °C | | |
| Weight | 1.0 gram(s) | | |

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

| Suffix | Thickness | Flatness / Parallelism | Hot Face | Cold Face | Lead Length |
|--------|--------------------------------------|--|----------|-----------|--------------------|
| 11 | 1.800 ±0.051 mm 0.071 ± 0.0020 in | 0.051 mm / 0.051 mm 0.002 in / 0.002 in | Lapped | Lapped | 50.8 mm 2.00 in |

SEALING OPTIONS

| Suffix | Sealant | Color | Temp Range | Description |
|--------|---------|-------|------------|----------------------|
| | None | | | No sealing specified |

NOTES

1. Max operating temperature: 150°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation

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